FAIRCHILD SEMICONDUCTOR®

May 2007

74F10
Triple 3-Input NAND Gate

General Description

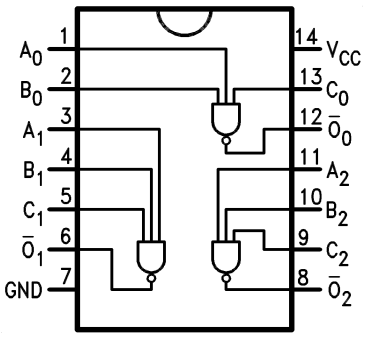
This device contains three independent gates, each of which performs the logic NAND function.

Ordering Information

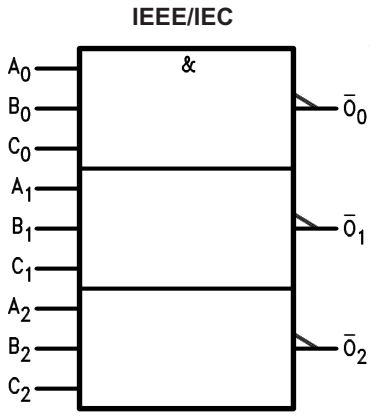
Order Number	Package Number	Package Description
74F10SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74F10SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter “X” to the ordering number.

Connection Diagram



Logic Symbol



Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input I_{IH}/I_{IL}, Output I_{OH}/I_{OL}
A_n, B_n, C_n	Inputs	1.0 / 1.0	20µA / –0.6mA
$\overline{O}_n$	Outputs	50 / 33.3	–1mA / 20mA

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Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
T_{STG}	Storage Temperature	–65°C to +150°C
T_A	Ambient Temperature Under Bias	–55°C to +125°C
T_J	Junction Temperature Under Bias	–55°C to +150°C
V_{CC}	V_{CC} Pin Potential to Ground Pin	–0.5V to +7.0V
V_{IN}	Input Voltage(1)	–0.5V to +7.0V
I_{IN}	Input Current(1)	–30mA to +5.0mA
V_O	Voltage Applied to Output in HIGH State (with V_{CC} = 0V)	
	Standard Output	–0.5V to V_{CC}
	3-STATE Output	–0.5V to 5.5V
	Current Applied to Output in LOW State (Max.)	twice the rated I_{OL} (mA)

Note:

1. Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
T_A	Free Air Ambient Temperature	0°C to +70°C
V_{CC}	Supply Voltage	+4.5V to +5.5V

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DC Electrical Characteristics

Symbol	Parameter		V_{CC}	Conditions	Min.	Typ.	Max.	Units
V_{IH}	Input HIGH Voltage			Recognized as a HIGH Signal	2.0			V
V_{IL}	Input LOW Voltage			Recognized as a LOW Signal			0.8	V
V_{CD}	Input Clamp Diode Voltage		Min.	I_{IN} = –18mA			–1.2	V
V_{OH}	Output HIGH Voltage	10% V_{CC}	Min.	I_{OH} = –1mA	2.5			V
		5% V_{CC}		I_{OH} = –1mA	2.7			
V_{OL}	Output LOW Voltage	10% V_{CC}	Min.	I_{OL} = 20mA			0.5	V
I_{IH}	Input HIGH Current		Max.	V_{IN} = 2.7V			5.0	µA
I_{BVI}	Input HIGH Current Breakdown Test		Max.	V_{IN} = 7.0V			7.0	µA
I_{CEX}	Output HIGH Leakage Current		Max.	V_{OUT} = V_{CC}			50	µA
V_{ID}	Input Leakage Test		0.0	I_{ID} = 1.9µA, All other pins grounded	4.75			V
I_{OD}	Output Leakage Circuit Current		0.0	V_{IOD} = 150mV, All other pins grounded			3.75	µA
I_{IL}	Input LOW Current		Max.	V_{IN} = 0.5V			–0.6	mA
I_{OS}	Output Short-Circuit Current		Max.	V_{OUT} = 0V	–60		–150	mA
I_{CCH}	Power Supply Current		Max.	V_O = HIGH		1.4	2.1	mA
I_{CCL}	Power Supply Current		Max.	V_O = LOW		5.1	7.7	mA

AC Electrical Characteristics

Symbol	Parameter	T_A = +25°C, V_{CC} = +5.0V, C_L = 50pF			T_A = –55°C to +125°C, V_{CC} = +5.0V, C_L = 50 pF		T_A = 0°C to +70°C, V_{CC} = +5.0V, C_L = 50pF		Units
		Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
t_{PLH}	Propagation Delay, A_n, B_n, C_n to $\overline{O}_n$	2.4	3.7	5.0	2.0	7.0	2.4	6.0	ns
t_{PHL}		1.5	3.2	4.3	1.5	6.5	1.5	5.3	

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Physical Dimensions

Dimensions are in millimeters unless otherwise noted.

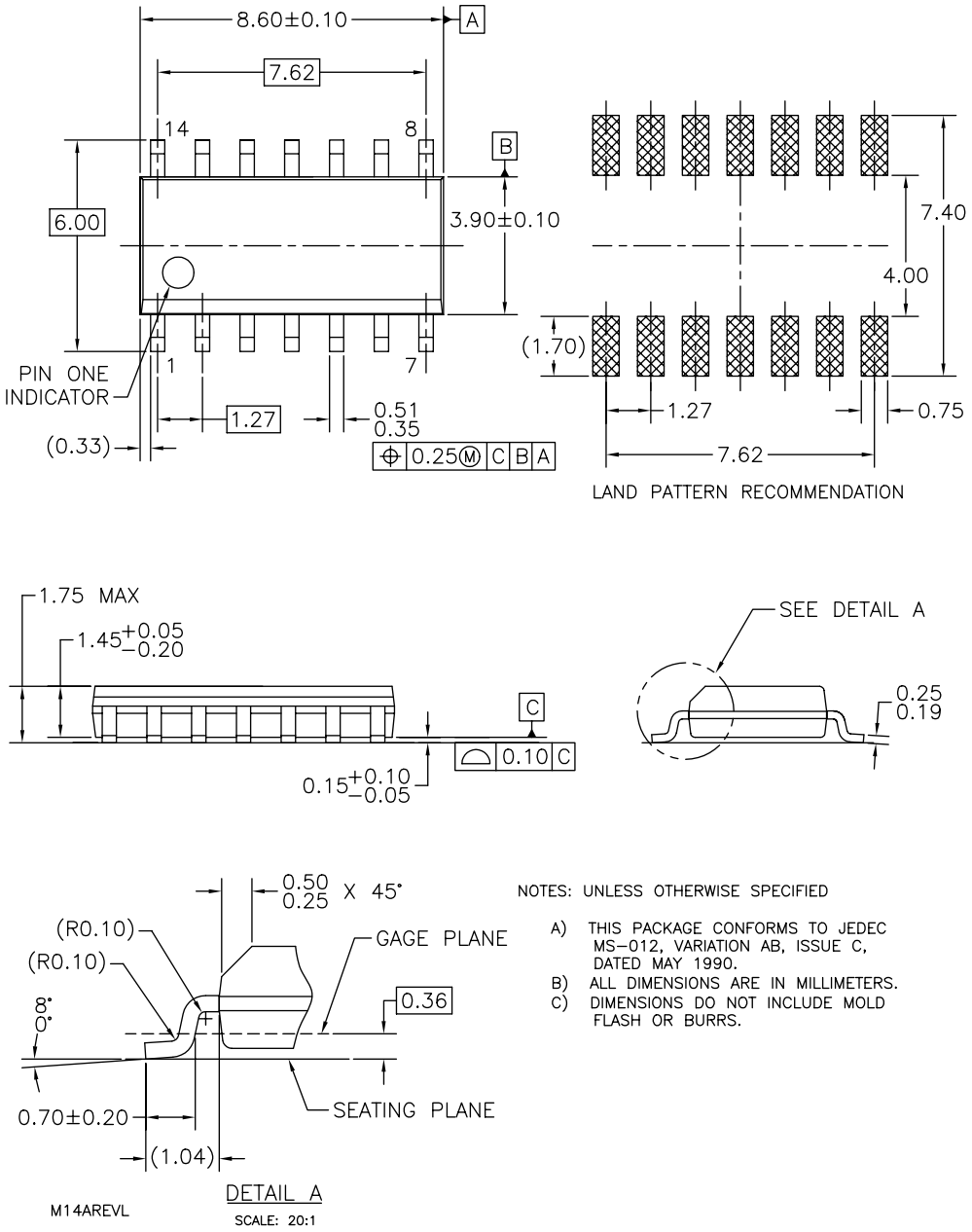

Figure 1. 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M14A

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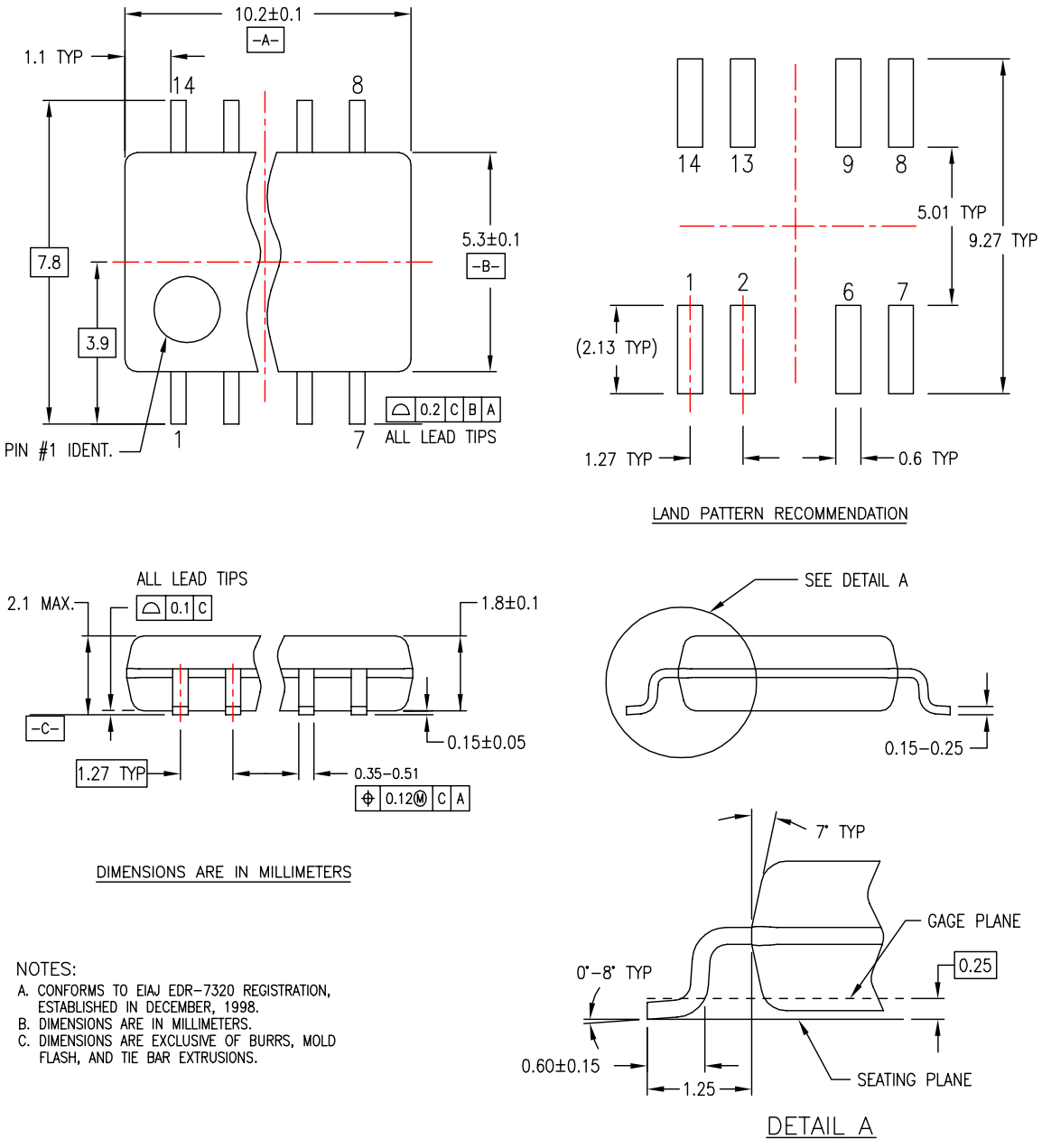
Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.



NOTES:

A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M14DREVC

Figure 2. 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M14D

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